# SEARCH REQUEST FORM

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Art Unit: 1752 Phone Mail Box and Bldg/Room Location  If more than one search is subnetween two	Number 30_ n: 9 D 6 Q Clew nitted, please ***********************************	Results Prioritize **********  d describe as a sayms, acronym	Serial Searches ****** specifically ans, and regist	in order of need.  **********************************	DISK E-MAIL  ************  to be searched.  th the concept or		
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Inventors (please provide full names):					6 REUD		
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Searcher:	NA Sequence (# AA Sequence (# Structure (#) Bibliographic Litigation Fulltext Patent Family Other	· · · · · · · · · · · · · · · · · · ·	Questel/Orbit _ Dr.Link Lexis/Nexis Sequence Syste	ms			

PTO-1590 (8-01)



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**CONFIRMATION NO. 4022** 

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Dib Data Sheet												
SERIAL NUMBI 10/694,719	ΕR	FILING DATE 10/29/2003 RULE	C	CLASS 430	GROUP ART UNIT 1752		ATTORNEY DOCKET NO. Q78208					
APPLICANTS	·		"									
Yoshiyuki Takata, Toyonaka-shi, JAPAN;												
Youngjoon Lee, Toyonaka-shi, JAPAN; Koshiro Ochiai, Toyonaka-shi, JAPAN;												
** CONTINUING DATA **********************************												
** FOREIGN APPLICATIONS ************************************												
IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 08/24/2004												
Foreign Priority claimed 35 USC 119 (a-d) condi met Verified and Acknowledged	itions	yes no yes no Allowance  Met aft	er tials	STATE OR COUNTRY JAPAN	DRA	EETS WING 0	TOTA CLAII 10	MS	INDEPENDENT CLAIMS 2			
ADDRESS 23373 SUGHRUE MION, PLLC 2100 PENNSYLVANIA AVENUE, N.W. SUITE 800 WASHINGTON, DC 20037												
TITLE Chemical amplification type positive resist composition												
FILING FEE	FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT FILING FEE No for following:							All Fees  1.16 Fees (Filing)  1.17 Fees (Processing Ext. of time)				

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L1
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L12
     FILE 'ZCAPLUS' ENTERED AT 14:22:55 ON 15 MAR 2005
L13
             15 S L11
     FILE 'REGISTRY' ENTERED AT 14:23:30 ON 15 MAR 2005
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## NODE ATTRIBUTES:

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CONNECT IS E1 RC AT 19
DEFAULT MLEVEL IS ATOM
GGCAT IS SAT AT 17
GGCAT IS SAT AT 19

DEFAULT ECLEVEL IS LIMITED

# GRAPH ATTRIBUTES:

RING(S) ARE ISOLATED OR EMBEDDED NUMBER OF NODES IS 18

# STEREO ATTRIBUTES: NONE L5 STR

# NODE ATTRIBUTES:

DEFAULT MLEVEL IS ATOM
DEFAULT ECLEVEL IS LIMITED

# GRAPH ATTRIBUTES:

RING(S) ARE ISOLATED OR EMBEDDED NUMBER OF NODES IS 15

STEREO ATTRIBUTES: NONE

L7 1728 SEA FILE=REGISTRY SSS FUL L5
L9 SCR 1313
L11 26 SEA FILE=REGISTRY SUB=L7 SSS FUL L4 NOT L9

100.0% PROCESSED 1517 ITERATIONS

26 ANSWERS

SEARCH TIME: 00.00.01

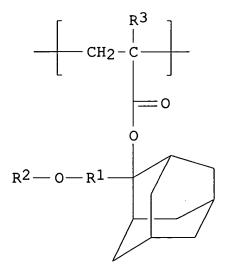
=> file zcaplus FILE 'ZCAPLUS' ENTERED AT 14:24:00 ON 15 MAR 2005 USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT. PLEASE SEE "HELP USAGETERMS" FOR DETAILS. COPYRIGHT (C) 2005 AMERICAN CHEMICAL SOCIETY (ACS)

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L13 ANSWER 1 OF 15 ZCAPLUS COPYRIGHT 2005 ACS on STN

2004:1128722 Document No. 142:82298 Chemical amplification-type positive-working resist composition containing acrylic polymer. Takada, Yoshiyuki; Li, Rong Bin; Ochiai, Koshiro (Sumitomo Chemical Co., Ltd., Japan). Jpn. Kokai Tokkyo Koho JP 2004359929 A2 20041224, 34 pp. (Japanese). CODEN: JKXXAF. APPLICATION: JP 2003-367050 20031028. PRIORITY: JP 2002-315517 20021030; JP 2003-131374 20030509.

GΙ



Disclosed is the chem. amplification-type pos.-working resist compn. comprising an acrylic resin represented by I (R1 = C1-4 alkylene; R2 = C1-4 alkyl; and R3 = H, Me). The fraction of I in the acrylic resin is 10-80%. In addn. to I, the resin may contain a polymer unit derived from 3-hydroxy-1-adamantyl (meth)acrylate, a polymer unit derived from (meth)acryloyloxy-.gamma.-butyrolactone, etc. The resist is suitable for an excimer laser lithog.

IT 811800-66-5P 811800-67-6P 811800-68-7P

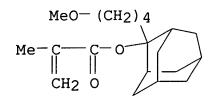
(photoacid for chem. amplification-type pos.-working resist compn. contg. acrylic polymer)

RN 811800-66-5 ZCAPLUS

CN 2-Propenoic acid, 2-methyl-, hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b]furan-6-yl ester, polymer with 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 501422-52-2 CMF C19 H30 O3



CM 2

CRN 254900-07-7 CMF C12 H14 O4

CRN 195000-66-9 CMF C8 H10 O4

RN 811800-67-6 ZCAPLUS

CN 2-Propenoic acid, 2-methyl-, hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b]furan-6-yl ester, polymer with 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 501422-52-2 CMF C19 H30 O3

CRN 254900-07-7 CMF C12 H14 O4

RN 811800-68-7 ZCAPLUS

CN 2-Propenoic acid, 2-methyl-, 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]d ec-2-yl ester, polymer with hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b]furan-6-yl 2-propenoate and 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 501422-52-2 CMF C19 H30 O3

CM 2

CRN 242129-35-7 CMF C11 H12 O4

CRN 216581-76-9 CMF C13 H18 O3

## IT 811800-66-5P 811800-67-6P 811800-68-7P

(photoacid for chem. amplification-type pos.-working resist compn. contg. acrylic polymer)

2004:1118877 Document No. 142:65315 Positive photoresist composition and method of forming pattern. Sato, Kenichiro (Fuji Photo Film Co., Ltd., Japan). Eur. Pat. Appl. EP 1489459 A1 20041222, 62 pp. DESIGNATED STATES: R: AT, BE, CH, DE, DK, ES, FR, GB, GR, IT, LI, LU, NL, SE, MC, PT, IE, SI, LT, LV, FI, RO, MK, CY, AL, TR, BG, CZ,

ANSWER 2 OF 15 ZCAPLUS COPYRIGHT 2005 ACS on STN

EE, HU, PL, SK, HR. (English). CODEN: EPXXDW. APPLICATION: EP 2004-14370 20040618. PRIORITY: JP 2003-173677 20030618; JP 2004-9104 20040116.

AB A pos. resist compn. comprising (A) a resin that increases soly. in a developing soln. by the action of an acid and comprises (a) a repeating unit contg. a group that is decompd. by the action of an acid to become alkali-sol., (b) a repeating unit contg. an alicyclic lactone structure, (c) a repeating unit contg. an alicyclic structure substituted with a hydroxy group and (d) a methacrylic acid repeating unit, wherein an amt. of the methacrylic acid repeating unit is from 5 to 18% by mole based on the total repeating units of the resin, and (B) a compd. that generates an acid upon

irradn. of an actinic ray or radiation. The object of the invention is to provide a pos. photoresist compn. which provides a wide process window in the formation of contact hole and restrains the formation of pit at the flow bake, and a method of forming a pattern using the inventive resist.

IT 811440-73-0P

(pos. photoresist compn. and method of forming pattern)

RN 811440-73-0 ZCAPLUS

CN 2-Propenoic acid, 2-methyl-, polymer with 5,7-dihydroxy-3-methyltricyclo[3.3.1.13,7]dec-1-yl 2-methyl-2-propenoate, hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b]furan-6-yl 2-methyl-2-propenoate and 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

.CRN 581784-05-6 CMF C18 H28 O3

CM 2

CRN 479081-09-9 CMF C15 H22 O4

CRN 254900-07-7 CMF C12 H14 O4

CM 4

CRN 79-41-4 CMF C4 H6 O2

IT 811440-73-0P

(pos. photoresist compn. and method of forming pattern)

L13 ANSWER 3 OF 15 ZCAPLUS COPYRIGHT 2005 ACS on STN 2004:1035977 Document No. 142:45893 Positive resist composition. Sato, Kenichiro (Fuji Photo Film Co., Ltd., Japan). Jpn. Kokai Tokkyo Koho JP 2004341247 A2 20041202, 73 pp. (Japanese). CODEN: JKXXAF. APPLICATION: JP 2003-137840 20030515.

AB Title compn. comprises (A) resin components contg. certain structural repeating units and having increased soly. in an alk. soln., (B) radiation-sensitive acid generators, and (C) solvents.

IT 801304-22-3 801304-25-6

(pos. resist compn/with good exposure margin)

RN 801304-22-3 ZCAPLUS

CN 2-Propenoic acid, 2-methyl-, 3,5-dihydroxytricyclo[3.3.1.13,7]dec-1-yl ester, polymer with 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-propenoate and 5-oxo-4-oxatricyclo[4.3.1.13,8]undec-1-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

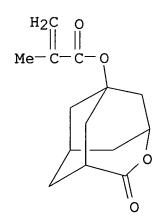
CRN 581784-05-6

CMF C18 H28 O3

$$MeO-(CH_2)_4$$
 $H_2C=CH-C-O$ 

CM 2

CRN 348596-87-2 CMF C14 H18 O4



CM :

CRN 115522-15-1 CMF C14 H20 O4

RN 801304-25-6 ZCAPLUS

CN 2-Propenoic acid, 2-methyl-, 3-hydroxy-5,7-dimethyltricyclo[3.3.1.13,7]dec-1-yl ester, polymer with 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-propenoate and 5-oxo-4-oxatricyclo[4.3.1.13,8]undec-1-yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 581784-05-6 CMF C18 H28 O3

$$MeO-(CH_2)_4$$
 $H_2C=CH-C-O$ 

CM 2

CRN 265999-35-7 CMF C13 H16 O4

CM 3

CRN 115522-17-3 CMF C16 H24 O3

$$H_2C$$
 O  $Me$   $Me$   $Me$   $Me$   $Me$   $Me$ 

# IT 801304-22-3 801304-25-6

(pos. resist compn. with good exposure margin)

L13 ANSWER 4 OF 15 ZCAPLUS COPYRIGHT 2005 ACS on STN
2004:824996 Document No. 141:340392 Positive resist composition and method of pattern formation. Yamanaka, Tsukasa; Sato, Kenichiro (Fuji Photo Film Co., Ltd., Japan). U.S. Pat. Appl. Publ. US 2004197707 A1 20041007, 52 pp. (English). CODEN: USXXCO. APPLICATION: US 2004-801723 20040317. PRIORITY: JP 2003-95804 20030331.

GΙ

AB A pos. resist compn. comprises: at least two resins which differ in glass transition temp. by at least 5.degree. C and have structural formulas I and II (R = H, OH, halogen, C1-4-alkyl, provided that R's are the same or different; A = single bond, alkylene, ether, thioether, carbonyl, ester, amide, sulfonamide, urethane, urea; W1 = alkylene group.); and a compd. which generates an acid upon irradn. with actinic rays or radiation, wherein each of the two resins comprises at least either of a repeating unit derived from an

acrylic acid deriv. monomer and a repeating unit derived from an methacrylic acid deriv. monomer and further comprises an alicyclic structure and at least one group that increases a soly. of the resin in alk. developer by the action of an acid. The object of the invention is to provide a resist compn. which is suitable for exposure to light having a wavelength of 200 nm or shorter, in particular, exposure with an ArF excimer laser, shows sufficient resoln. even in ordinary pattern formation, and has such thermal flow suitability that a reduced pattern size can be obtained only through flow bake at an appropriate temp., and it is easy to regulate the flow amt. while attaining an appropriate flow rate.

IT 581784-06-7P

(pos. resist compn. and method of pattern formation)

RN 581784-06-7 ZCAPLUS CN 2-Propenoic acid, 2-

2-Propenoic acid, 2-methyl-, 3,5-dihydroxytricyclo[3.3.1.13,7]dec-1-yl ester, polymer with hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b]furan-6-yl 2-methyl-2-propenoate and 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 581784-05-6 CMF C18 H28 O3

$$MeO-(CH_2)_4$$
 $H_2C=CH-C-O$ 

CM 2

CRN 254900-07-7 CMF C12 H14 O4

CRN 115522-15-1 CMF C14 H20 O4

#### IT 581784-06-7P

(pos. resist compn. and method of pattern formation)

L13 ANSWER 5 OF 15 ZCAPLUS COPYRIGHT 2005 ACS on STN
2004:802414 Document No. 141:322575 Positive working chemically amplified photoresist composition producing patterns with reduced line edge roughness. Nakao, Hajime; Momota, Makoto (Fuji Photo Film Co., Ltd., Japan). U.S. Pat. Appl. Publ. US 2004191676 A1 20040930, 58 pp. (English). CODEN: USXXCO. APPLICATION: US 2004-809389 20040326. PRIORITY: JP 2003-89021 20030327.

AB A pos. photoresist is described that produces patterns with reduced line edge roughness and allowing wide defocuss latitude in forming various patterns. The photoresist formulation includes a photoacid generator, a solvent and a matrix resin comprising .gtoreq. 1 acrylate deriv. repeating units, repeating units having lactone structures and repeating units having OH group-substituted adamantane structures. The resin has glass transition temp. in the range of 70- 155.degree. C. and is capable of increasing its soly. in an alkali developer.

#### IT 581784-06-7P

(pos. working chem. amplified photoresist formulation that produces patterns with reduced line edge roughness)

RN 581784-06-7 ZCAPLUS

CN 2-Propenoic acid, 2-methyl-, 3,5-dihydroxytricyclo[3.3.1.13,7]dec-1-yl ester, polymer with hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b]furan-6-yl 2-methyl-2-propenoate and 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 581784-05-6 CMF C18 H28 O3

$$MeO-(CH_2)_4$$
 $H_2C=CH-C-O$ 

CM 2

CRN 254900-07-7 CMF C12 H14 O4

CM 3

CRN 115522-15-1 CMF C14 H20 O4

#### IT 581784-06-7P

(pos. working chem. amplified photoresist formulation that produces patterns with reduced line edge roughness)

L13 ANSWER 6 OF 15 ZCAPLUS COPYRIGHT 2005 ACS on STN
2004:700962 Document No. 141:197371 Chemically amplified
positive-working photoresist compositions for far-UV lithography.
Sato, Kenichiro; Yamanaka, Tsukasa; Momota, Atsushi (Fuji Photo Film
Co., Ltd., Japan). Jpn. Kokai Zokkyo Koho JP 2004240044 A2
20040826, 73 pp. (Japanese). CODEN: JKXXAF. APPLICATION: JP
2003-27202 20030204.

$$\begin{array}{c|c}
H \\
CH_2 C \\
\hline
CO-O
\end{array}$$

$$\begin{array}{c|c}
R8 \\
R7
\end{array}$$

The photoresist compns. contain polymers (A) whose all repeating units are acrylate esters including alicyclic lactone acrylate ester repeating unit and adamantane acrylate repeating unit I (R6-8 = H, OH, alkyl; at least one of R6-8 is OH) and increase soly. rate in alk. developers by acid action, photoacid generators (B), and solvents (C). The compns. have less dependence on post-exposure-baking temp., and provide good-profile patterns with good surface smoothness.

Ι

IT 738587-52-5P

(in far-UV pos. photoresists contg. adamantane acrylate-alicyclic lactone copolymers and photoacid generators)

RN 738587-52-5 ZCAPLUS

CN 2-Propenoic acid, 3,5-dihydroxytricyclo[3.3.1.13,7]dec-1-yl ester, polymer with hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b]furan-6-yl 2-propenoate and 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 581784-05-6 CMF C18 H28 O3

CM 2

CRN 242129-35-7 CMF C11 H12 O4

CM 3

CRN 216581-85-0 CMF C13 H18 O4

## IT 738587-52-5P

(in far-UV pos. photoresists contg. adamantane acrylate-alicyclic lactone copolymers and photoacid generators)

L13 ANSWER 7 OF 15 ZCAPLUS COPYRIGHT 2005 ACS on STN
2004:433363 Document No. 140:431417 Chemically amplified
positive-working far-UV photoresist compositions. Sato, Kenichiro
(Fuji Photo Film Co., Ltd., Japan) Jpn. Kokai Tokkyo Koho JP
2004151364 A2 20040527, 69 pp. (Japanese). CODEN: JKXXAF.
APPLICATION: JP 2002-316354 20021030.

GΙ

AB The compns. contain polymers increasing soly. rate in alk. developers upon acid action and contg. repeating units of A1-3 including [A1; CH2C(R1)(CO2LZ)] [R1 = H, alkyl; L = single bond, alkylene, ether, ester, etc.; Z = CO2H, OH, SO2N(R3)2, COCH2COR4, etc.; R3, R5-7 = H, alkyl; R4 = hydrocarbyl; m = 1-20; Z =[CH(R5)CH(R6)O]mR7 when L = single bond], [A2; CH2C(R2)(ACO2ALG)] [R2 = H, Me; A = single bond, connecting group; ALG = Q, etc.; R11 = Me, Et, Pr, etc.; Z = at. group forming alicyclic hydrocarbylene group with carbon], and [A3; CH2C(R3)(A'Z3(OH)p)] [R3 = H, Me; A' = single bond, divalent connecting group; Z3 = alicyclic hydrocarbylene having valences of (p + 1); p = 1-3; naphthalene sulfonate photoacid generator I [RB1-B2 = H, C1-4 alkyl; RB3 = OH, ORB4; RB4 = C1-15 monovalent org. group; A1- = monovalent anion; a = 4-7; b = 0-7]; and solvents. The polymers may further contain repeating units of cyclohexanelactone, norbornane lactone, or adamantane lactone. The compns. provide good pattern profile.

IT 680223-08-9

CN

(in chem. amplified pos.-working far-UV photoresist compns. contg. naphthalene sulfonate photoacid generators)

RN 680223-08-9 ZCAPLUS

2-Propenoic acid, 2-methyl-, 3,5-dihydroxytricyclo[3.3.1.13,7]dec-1-yl ester, polymer with hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b]furan-6-yl 2-methyl-2-propenoate, 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-propenoate, 2-(2-methoxyethoxy)ethyl 2-methyl-2-propenoate and 1-methyl-1-tricyclo[3.3.1.13,7]dec-1-ylethyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 581784-05-6 CMF C18 H28 O3

$$MeO-(CH_2)_4$$
 $H_2C=CH-C-O$ 

CM 2

CRN 279218-76-7 CMF C17 H26 O2

CM 3

CRN 254900-07-7 CMF C12 H14 O4

CRN 115522-15-1 CMF C14 H20 O4

CM 5

CRN 45103-58-0 CMF C9 H16 O4

IT 680223-08-9

(in chem. amplified pos.-working far-UV photoresist compns. contg. naphthalene sulfonate photoacid generators)

L13 ANSWER 8 OF 15 CCAPLUS COPYRIGHT 2005 ACS on STN
2004:430044 Document No. 140:414953 Chemically amplified
positive-working far-UV photoresist compositions. Sato, Kenichiro;
Kodama, Kunihiko (Fuji Photo Film Co., Ltd., Japan). Jpn. Kokai
Tokkyo Koho JP 2004151355 A2 20040527, 75 pp. (Japanese). CODEN:
JKXXAF. APPLICATION: JP 2002-316284 20021030.

GI

AB The compns. contain polymers increasing soly. rate in alk. developers upon acid action and contq. repeating units of A1-3 including [A1; CH2C(R1)(CO2LZ)] [R1 = H, alkyl; L = single bond, alkylene, ether, ester, etc.; Z = CO2H, OH, SO2N(R3)2, COCH2COR4, etc.; R3, R5-7 = H, alkyl; R4 = hydrocarbyl; m = 1-20; Z =[CH(R5)CH(R6)O]mR7 when L = single bond], [A2; CH2C(R2)(ACO2ALG)] [R2 = H, Me; A = single bond, connecting group; ALG = Q, etc.; R11 = Me, Et, Pr, etc.; Z = at. group forming alicyclic hydrocarbylene group with carbon], and [A3; CH2C(R3)(A'Z3(OH)p)] [R3 = H, Me; A' = single bond, divalent connecting group; Z3 = alicyclic hydrocarbylene having valences of (p + 1); p = 1-3; sulfonate enone photoacid generator I or II [RB1-B3 = H, alkyl, alkenyl, etc.; RB4-B5 = H, cyano, alkyl, etc.; Y1-2 = alkyl, aryl, aralkyl, etc.; n = 1-4; .gtoreq.2 selected from RB1-B5 and Y1-2 may form a ring; .gtoreq.2 selected from RB1-B5 and Y1-2 may be bonded to via a connecting group so as to have .gtoreq.2 structure of I and/or II; X- = nonnucleophilic anion]; and solvents. The polymers may further contain repeating units of cyclohexanelactone, norbornane lactone, or adamantane lactone. The compns. provide sharp line edge patterns.

IT 680223-08-9

CN

(in chem. amplified pos.-working far-UV photoresist compns. contg. sulfonate enone photoacid generators)

RN 680223-08-9 ZCAPLUS

2-Propenoic acid, 2-methyl-, 3,5-dihydroxytricyclo[3.3.1.13,7]dec-1-yl ester, polymer with hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b]furan-6-yl 2-methyl-2-propenoate, 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-propenoate, 2-(2-methoxyethoxy)ethyl 2-methyl-2-propenoate and 1-methyl-1-tricyclo[3.3.1.13,7]dec-1-ylethyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 581784-05-6 CMF C18 H28 O3

$$MeO-(CH_2)_4$$
 $H_2C=CH-C-O$ 

CRN 279218-76-7 CMF C17 H26 O2

$$\begin{array}{c|c} H_2C & O \\ \parallel & \parallel \\ Me-C-C-O \\ Me-C \\ Me \end{array}$$

CM 3

CRN 254900-07-7 CMF C12 H14 O4

CM 4

CRN 115522-15-1 CMF C14 H20 O4

CRN 45103-58-0 CMF C9 H16 O4

#### IT 680223-08-9

(in chem. amplified pos.-working far-UV photoresist compns. contg. sulfonate enone photoacid generators)

L13 ANSWER 9 OF 15 ZCAPLUS COPYRIGHT 2005 ACS on STN 2004:310383 Document No. 140:347505 Photo-acid generation type positive-working photoresist composition. Sato, Kenichiro (Fuji Photo Film Co., Ltd., Japan). Jpn. Kokai Tokkyo Koho JP 2004117883 A2 20040415, 79 pp. (Japanese). CODEN: JKXXAF. APPLICATION: JP 2002-281545 20020926.

AB The disclosed photoresist compn. contains a photo-acid generating agent and a vinyl polymer comprising first repeating units whose monomer has a specified end group, second repeating units having decomposable group protected by alicyclic structure, and third repeating units having acid having alicyclic alc. moiety. The photoresist compn. has good sensitivity towards ArF excimer laser radiation and give fine line patterns without undesirable bridging.

IT 680223-08-9P

(far UV sensitive photoacid generation type pos. working photoresist contg.)

RN 680223-08-9 ZCAPLUS

CN 2-Propenoic acid, 2-methyl-, 3,5-dihydroxytricyclo[3.3.1.13,7]dec-1-yl ester, polymer with hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b]furan-6-yl 2-methyl-2-propenoate, 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-propenoate, 2-(2-methoxyethoxy)ethyl 2-methyl-2-propenoate and 1-methyl-1-tricyclo[3.3.1.13,7]dec-1-ylethyl 2-methyl-2-propenoate

(9CI) (CA INDEX NAME)

CM 1

CRN 581784-05-6 CMF C18 H28 O3

$$MeO-(CH_2)_4$$
 $H_2C=CH-C-O$ 

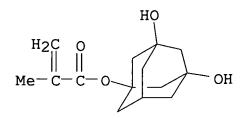
CM 2

CRN 279218-76-7 CMF C17 H26 O2

CM :

CRN 254900-07-7 CMF C12 H14 O4

CRN 115522-15-1 CMF C14 H20 O4



CM 5

CRN 45103-58-0 CMF C9 H16 O4

$$^{\rm H_2C}$$
 O  $^{\rm ||}$  ||  $^{\rm ||}$  Me-C-C-O-CH<sub>2</sub>-CH<sub>2</sub>-O-CH<sub>2</sub>-OMe

## IT 680223-08-9P

(far UV sensitive photoacid generation type pos. working photoresist contg.)

L13 ANSWER 10 OF 15 ZCAPLUS COPYRIGHT 2005 ACS on STN

2004:271951 Document No. 140:294796 Excimer laser-sensitive chemically amplified photoresist compositions with high sensitivity, resolution, and etching resistance. Sato, Kenichiro (Fuji Photo Film Co., Ltd., Japan). Jpn. Kokai Tokkyo Koho JP 2004101642 A2 20040402, 81 pp. (Japanese). CODEN: JKXXAF. APPLICATION: JP 2002-260191 20020905.

AB The compns., useful for manufg. semiconductor devices, comprise (A) resins with Tg 120-180.degree. increasing their alkali soly. by acid-induced decompn., (B) photoacid generators, and (C) solvents, wherein the resins have partial structures of OH groups substituted by alicyclic hydrocarbon groups. The alicyclic structures may have adamantane groups.

IT 676260-16-5P

(excimer laker-sensitive photoresists with high sensitivity, resoln., and etching resistance)

RN 676260-16-5 ZCAPLUS

CN 2-Propenoic acid, 2-methyl-, 3,5-dihydroxytricyclo[3.3.1.13,7]dec-1-yl ester, polymer with hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b]furan-6-yl 2-propenoate and 2-(3-methoxypropyl)tricyclo[3.3.1.13,7]dec-2-yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 676260-15-4 CMF C17 H26 O3

$$MeO-(CH_2)_3$$
 $H_2C=CH-C-O$ 

CM 2

CRN 242129-35-7 CMF C11 H12 O4

CM 3

CRN 115522-15-1 CMF C14 H20 O4

#### IT 676260-16-5P

(excimer laser-sensitive photoresists with high sensitivity, resoln., and etching resistance)

ANSWER 11 OF 15 ZCAPLUS COPYRIGHT 2005 ACS on STN 2003:991472 Document No. 140:28360 2-alkoxyalkyl-2-adamantyl (meth)acrylate. Bae, Eun Hyoung; Song, Young Bae; Oh, Dong Ju (ENF Technology Co., Ltd., S. Korea). PCT Int. Appl. WO 2003104182 A1 20031218, 14 pp. DESIGNATED STATES: W: AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ, NI, NO, NZ, OM, PH, PL, PT, RO, RU, SC, SD, SE, SG, SK, SL, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, YU, ZA, ZM, ZW; RW: AT, BE, BF, BJ, CF, CG, CH, CI, CM, CY, DE, DK, ES, FI, FR, GA, GB, GR, IE, IT, LU, MC, ML, MR, NE, NL, PT, SE, SN, TD, TG, TR. (English). APPLICATION: WO 2003-KR1151 20030611. PRIORITY: KR CODEN: PIXXD2. 2002-32554 20020611.

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$$\begin{array}{c} R^2 \\ H_2C \longrightarrow 0 \\ R^1O = CH_2 \longrightarrow 0 \\ \end{array}$$

AB 2-Alkoxyalkyl-2-adamantyl (meth)acrylate I (R1 = H, C1-4 alkyl, C3-8 cycloalkyl; R2 = H, methyl; N = integer) is used as monomer for

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prodn. of photocurable resin or as drug intermediate. Thus, 120.17 g 2-adamantanone was reacted with 4-methoxybutylmagnesium chloride obtained from magnesium 26.7 and 4-methoxybutyl chloride 108.57 g to form 2-(methoxybutyl)-2-adamantanol (yield 80%), 44.87 g of which was reacted with 25.34 g acryloyl chloride in the presence of 32.38 g triethylamine to give 2-(4-methoxybutyl)-2-adamantyl acrylate in yield 80%.

## IT 634590-63-9P 634590-64-0P

(prepn. of 2-alkoxyalkyl-2-adamantyl (meth) acrylate for photocurable resin and drug)

RN 634590-63-9 ZCAPLUS

CN 2-Propenoic acid, 2-(4-methoxybutyl)-6-oxotricyclo[3.3.1.13,7]dec-2-yl ester (9CI) (CA INDEX NAME)

RN 634590-64-0 ZCAPLUS

CN 2-Propenoic acid, 2-methyl-, 2-(4-methoxybutyl)-6oxotricyclo[3.3.1.13,7]dec-2-yl ester (9CI) (CA INDEX NAME)

## IT 634590-63-9P 634590-64-0P

(prepn. of 2-alkoxyalkyl-2-adamantyl (meth) acrylate for photocurable resin and drug)

L13 ANSWER 12 OF 15 ZCAPLUS COPYRIGHT 2005 ACS on STN 2003:907515 Document No. 139:401544 Positive-working chemically amplification type photoresist composition showing improved pattern profile and line edge roughness. Sato, Kenichiro (Fuji Photo Film Co., Ltd., Japan). Jpn. Kokai Tokkyo Koho JP 2003330194 A2 20031119, 81 pp. (Japanese). CODEN: JKXXAF. APPLICATION: JP

2002-138810 20020514.

·GΙ

The title photoresist compn., esp. sensitive to a ArF excimer laser stepper, comprises (A) a photoacid generator represented by I [R1-5 = H, alkyl, alkoxy, halo; R6, R7 = H, alkyl, aryl; R8, R9 = alkyl, 2-oxoalkyl, alkoxycarbonylmethyl, allyl, vinyl; X- = sulfonic, carboxylic, sulfonylimide anion] or S+(R1)(R2)(R3).X- [R1-3 = alkyl, 2-oxoalkyl; X- = anion] and (B) an alk.-developable resin contg. structural repeating units of CH(R1):CH(OR2) [R1 = H, hydrocarbyl; R2 = hydrocarbyl], II [Z = O, NR3; R3 = H, OH, alkyl, haloalkyl, OSO2R4; R4 = alkyl, haloalkyl, cycloalkyl, camphoryl], and CH2:C(R)(A1COOA2(Z2)1(A3R')m) [R = H, methyl; A1 = single bond, connection bond; A2 = single bond, alkylene, ether, ester; Z2 = alicyclic hydrocarbyl; l = 0, 1; A3 = single bond, alkylene, ether, ester; R' = CN; m = 1-3]. The photoresist compn. is suitable for microphotofabrication processes.

IT 625422-33-5P 625422-43-7P

(pos.-working chem. amplification type photoresist compn. showing improved pattern profile and line edge roughness)

RN 625422-33-5 ZCAPLUS

CN 2-Propenoic acid, 2-cyanoethyl ester, polymer with (ethenyloxy)cyclohexane, 2,5-furandione and 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 581784-05-6 CMF C18 H28 O3

$$MeO-(CH_2)_4$$
 $H_2C=CH-C-O$ 

CRN 2182-55-0 CMF C8 H14 O

CM 3

CRN 108-31-6 CMF C4 H2 O3

CM 4

CRN 106-71-8 CMF C6 H7 N O2

$$\begin{array}{c} & \text{O} \\ || \\ \text{NC-CH}_2\text{--CH}_2\text{--O-C-CH} \end{array}$$

RN 625422-43-7 ZCAPLUS

CN Tricyclo[3.3.1.13,7]decane-1-carboxylic acid, 2-(ethenyloxy)ethyl

ester, polymer with 8a-cyanooctahydro-4a(2H)-naphthalenyl 2-propenoate, 2,5-furandione and 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 625422-42-6 CMF C14 H19 N O2

CM 2

CRN 581784-05-6 CMF C18 H28 O3

$$MeO-(CH_2)_4$$
 $H_2C=CH-C-O$ 

CM 3

CRN 219774-72-8 CMF C15 H22 O3

CRN 108-31-6 CMF C4 H2 O3

#### IT 625422-33-5P 625422-43-7P

(pos.-working chem. amplification type photoresist compn. showing improved pattern profile and line edge roughness)

L13 ANSWER 13 OF 15 ZCAPLUS COPYRIGHT 2005 ACS on STN
2003:907503 Document No. 139;388487 Positive-working light-sensitive photoresist composition containing specific photoacid generator and specific resin. Sato, Kenichiro; Kodama, Kunihiko (Fuji Photo Film Co., Ltd., Japan). Jpn. Kokai Tokkyo Koho JP 2003330172 A2 20031119, 70 pp. (Japanese). CODEN: JKXXAF. APPLICATION: JP 2002-138809 20020514.

The title compn. contains a photoacid generator and a resin increasing in an alkali developer by reacting with an acid, wherein the photoacid generator has general structure I(R1c-5c = H, alkyl, alkoxy, etc.; R6c-7c = H, alkyl, aryl; Rx, Ry = alkyl, 2-oxoalkyl, alkoxycarbonylmethyl, ally, vinyl; X- = sulfonate, carboxylate, sulfonylamide anion) or (R1d) (R2d) (R3d)S+ X-(R1d-3d = alkyl, 2-oxoalkyl; X- = anion) and wherein the resin has repeating unit II(R1-4 = H, cyano, hydrocarbon, etc.; m = 0, 1). The compn. is

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suitable use with ArF excimer laser and SOG substrates and provides photoresists of the good profile.

IT 625092-97-9P

(pos.-working light-sensitive photoresist compn.)

RN 625092-97-9 ZCAPLUS

CN 2-Propenoic acid, 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 4',5'-dihydrospiro[bicyclo[2.2.1]hept-5-ene-2,3'(2'H)-furan]-2'-one and 2,5-furandione (9CI) (CA INDEX NAME)

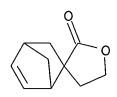
CM 1

CRN 581784-05-6 CMF C18 H28 O3

MeO- (CH<sub>2</sub>) 4
$$H_2C$$
= CH- C- 0

CM 2

CRN 72377-80-1 CMF C10 H12 O2



CM 3

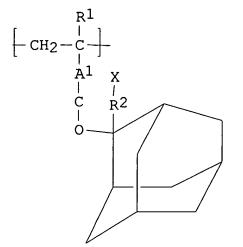
CRN 108-31-6 .CMF C4 H2 O3

#### IT 625092-97-9P

(pos.-working light-sensitive photoresist compn.)

L13 ANSWER 14 OF 15 ZCAPLUS COPYRIGHT 2005 ACS on STN
2003:675602 Document No. 139:188325 Positive resist composition.
Sato, Kenichiro (Fuji Photo Film Co., Ltd., Japan). Eur. Pat. Appl.
EP 1338922 A2 20030827, 76 pp. DESIGNATED STATES: R: AT, BE, CH,
DE, DK, ES, FR, GB, GR, IT, LI, LU, NL, SE, MC, PT, IE, SI, LT, LV,
FI, RO, MK, CY, AL, TR, BG, CZ, EE, HU, SK. (English). CODEN:
EPXXDW. APPLICATION: EP 2003-3244 20030221. PRIORITY: JP
2002-44665 20020221.





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AB A pos. resist compn. comprises: (A) a resin which comprises a repeating unit represented by I (R1 = H, alkyl group; A1 = single bond or a linking group; R2 = alkylene group; X = alkoxy group, hydroxyl group), which exhibits an increased rate of dissoln. in an alkali developing soln. by an action of an acid; and (B) a compd. capable of generating an acid on exposure to active light rays or a radiation.

IT 581784-06-7P 581784-07-8P 581784-08-9P 581784-11-4P 581784-13-6P 581799-31-7P 581799-32-8P

(pos. resist compn. contq.)

RN 581784-06-7 ZCAPLUS

CN 2-Propenoic acid, 2-methyl-, 3,5-dihydroxytricyclo[3.3.1.13,7]dec-1-yl ester, polymer with hexahydro-2-oxo-3,5-methano-2H-

cyclopenta[b]furan-6-yl 2-methyl-2-propenoate and
2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-propenoate (9CI)
(CA INDEX NAME)

CM 1

CRN 581784-05-6 CMF C18 H28 O3

$$MeO-(CH_2)_4$$
 $H_2C=CH-C-O$ 

CM 2

CRN 254900-07-7 CMF C12 H14 O4

CM 3

CRN 115522-15-1 CMF C14 H20 O4

RN 581784-07-8 ZCAPLUS

CN 2-Propenoic acid, 2-methyl-, 3,5-dihydroxytricyclo[3.3.1.13,7]dec-1-yl ester, polymer with 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl 2-methyl-2-propenoate, 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and tetrahydro-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 501422-52-2 CMF C19 H30 O3

CM 2

CRN 195000-66-9 CMF C8 H10 O4

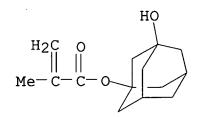
CM 3

CRN 115522-15-1

CMF C14 H20 O4

'CM 4

CRN 115372-36-6 CMF C14 H20 O3



RN 581784-08-9 ZCAPLUS

CN 2-Propenoic acid, 2-methyl-, 4-hydroxybicyclo[2.2.1]hept-1-yl ester, polymer with 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-propenoate, 2-(2-methoxyethoxy)ethyl 2-methyl-2-propenoate and 7-oxo-6-oxabicyclo[3.2.1]oct-4-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 581784-05-6 CMF C18 H28 O3

$$MeO-(CH_2)_4$$
 $H_2C=CH-C-O$ 

CRN 508210-21-7 CMF C11 H16 O3

CM 3

CRN 335163-70-7 CMF C11 H14 O4

CM 4

CRN 45103-58-0 CMF C9 H16 O4

$$^{\rm H_2C}$$
  $^{\rm O}$   $^{\rm O}$   $^{\rm H_2C}$   $^{\rm O}$   $^{\rm$ 

RN 581784-11-4 ZCAPLUS

CN 2-Propenoic acid, hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b]furan-

6-yl ester, polymer with 3-hydroxy-5-methyltricyclo[3.3.1.13,7]dec-1-yl 2-methyl-2-propenoate, 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-propenoate and 1-methyl-1-tricyclo[3.3.1.13,7]dec-1-ylethyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 581784-05-6 CMF C18 H28 O3

$$MeO-(CH_2)_4$$
 $H_2C=CH-C-O$ 

CM 2

CRN 476312-25-1 CMF C15 H22 O3

CM 3

CRN 279218-76-7 CMF C17 H26 O2

CRN 242129-35-7 CMF C11 H12 O4

RN 581784-13-6 ZCAPLUS

CN 2-Propenoic acid, 2-methyl-, 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]d ec-2-yl ester, polymer with 3-hydroxytricyclo[3.3.1.13,7]dec-1-yl 2-propenoate, tetrahydro-5,5-dimethyl-2-oxo-3-furanyl 2-methyl-2-propenoate and 1,7,7-trimethylbicyclo[2.2.1]hept-2-yl 2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 501422-52-2 CMF C19 H30 O3

CRN 280552-09-2 CMF C10 H14 O4

$$\begin{array}{c|c} & & & & \\ & & & \\ H_2C & O & & \\ \parallel & \parallel & \\ Me-C-C-O & & \end{array}$$

CM 3

CRN 216581-76-9 CMF C13 H18 O3

CM 4

CRN 128946-20-3 CMF C13 H20 O2

$$H_2C = CH - C - O$$

$$Me$$

$$Me$$

$$Me$$

$$Me$$

RN 581799-31-7 ZCAPLUS

CN 2-Propenoic acid, 2-methyl-, octahydro-1,2(or 2,3)-dihydroxy-4,7-methano-1H-inden-5-yl ester, polymer with 2-(4-

ethoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-propenoate and octahydro-1-oxo-4,7-methanoisobenzofuran-5-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 581799-30-6 CMF C19 H30 O3

EtO- (CH<sub>2</sub>) 4

$$H_2C$$
=  $CH$ -  $C$ -  $O$ 

CM 2

CRN 386729-67-5 CMF C13 H16 O4

CM 3

CRN 309260-42-2 CMF C14 H20 O4

CCI IDS

D1-OH

RN 581799-32-8 ZCAPLUS

CN 2-Propenoic acid, 2-methyl-, 2-methyltricyclo[3.3.1.13,7]dec-2-yl ester, polymer with 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-propenoate, octahydro-1,2(or 2,3)-dihydroxy-4,7-methano-1H-inden-5-yl 2-methyl-2-propenoate and tetrahydro-2-oxo-3-furanyl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 581784-05-6 CMF C18 H28 O3

$$MeO-(CH_2)_4$$
 $H_2C=CH-C-O$ 

CM 2

CRN 309260-42-2 CMF C14 H20 O4

CCI IDS

D1- OH

CM 3

CRN 195000-66-9 CMF C8 H10 O4

CM 4

CRN 177080-67-0 CMF C15 H22 O2

IT 581784-06-7P 581784-07-8P 581784-08-9P 581784-11-4P 581784-13-6P 581799-31-7P 581799-32-8P

(pos. resist compn. contg.)

L13 ANSWER 15 OF 15 ZCAPLUS COPYRIGHT 2005 ACS on STN

2003:214743 Document No. 138:238854 (Meth)acrylic acid copolymers with narrow molecular weight distribution and their manufacture.

Matsumoto, Hitoshi; Nakamura, Mitsuhiro (Nippon Soda Co., Ltd., Japan). Jpn. Kokai Tokkyo Koho JP 2003082010 A2 20030319, 24 pp. (Japanese). CODEN: JKXXAF. APPLICATION: JP 2001-272949 20010910.

The copolymers suitable for ArF excimer laser photoresist base resins, are manufd. by copolymg. .gtoreq.2 (meth)acrylate esters in the presence of anionic polymn. initiators and 0.1-1.0 equiv mol ratio (based on the initiators) of mineral acid alkali metal and/or alk. earth metal salts and have repeating units CH2CR1CO2AB (R1 = H, C1-5 alkyl; A = single bond, ether, ester, carbonyl, alkylene, or their combination; B = lactone residue) and Mw/Mn 1.01-1.50. Thus, 2-methyl-2-adamantyl methacrylate was reacted with methacrylic acid-5-oxo-4-oxatricyclo[4.2.1.03,7]nonan-2-yl in the presence of LiCl and sec-butyllithium to give a polymer showing Mw/Mn 1.29.

IT 501422-53-3P

((meth)acrylate copolymers with narrow mol. wt. distribution and their manuf. with anionic polymn. initiators and mineral acid alkali or alk. earth metal salts)

RN 501422-53-3 ZCAPLUS

CN 2-Propenoic acid, 2-methyl-, hexahydro-2-oxo-3,5-methano-2H-cyclopenta[b]furan-6-yl ester, polymer with 2-(4-methoxybutyl)tricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate and 2-methyltricyclo[3.3.1.13,7]dec-2-yl 2-methyl-2-propenoate (9CI) (CA INDEX NAME)

CM 1

CRN 501422-52-2 CMF C19 H30 O3

CM 2

CRN 254900-07-7 CMF C12 H14 O4

CRN 177080-67-0 CMF C15 H22 O2

## IT 501422-53-3P

((meth)acrylate copolymers with narrow mol. wt. distribution and their manuf. with anionic polymn. initiators and mineral acid alkali or alk. earth metal salts)